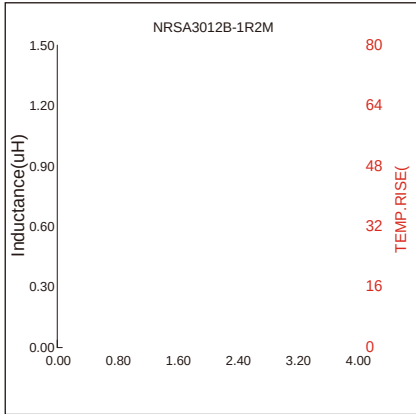




Typical Electrical Characteristics:





Soldering Reflow:

Preheat condition: 150 ~200 ℃ / 60~120 sec.

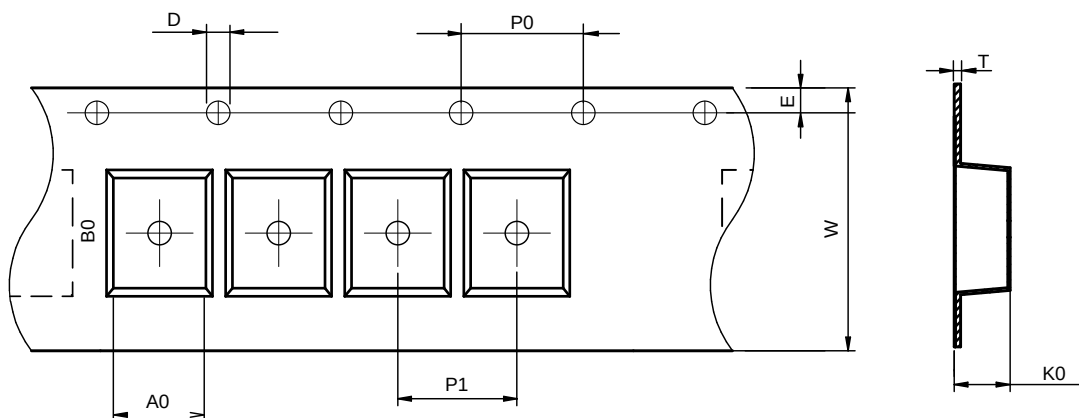
Allowed time above 217 ℃ : 60~90 sec.

Max temperature: 260 ℃.

Allowed Reflow time: 2x max.

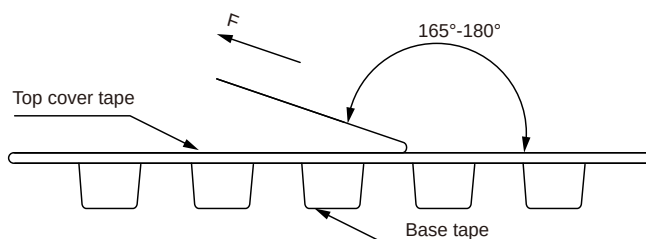
Packaging Information:

Tape Dimension :



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
NRSA3012B	3.3 ± 0.1	3.3 ± 0.1	1.5 ± 0.1	4.0 ± 0.1	4.0 ± 0.1	8.0 ± 0.1	1.4 ± 0.1	1.75 ± 0.1	0.23 ± 0.05

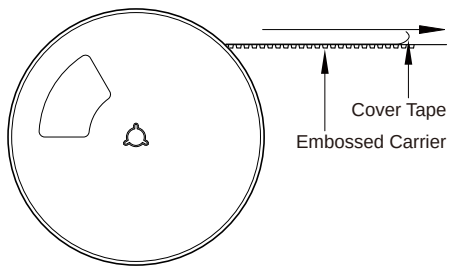
Peel force of top cover tape:



The peel force of top cover tape shall be between 0.3 to 1.17 N



Reel Dimension: [mm]



Packaging Quantity: